# UNR5154 (UN5154)

### Silicon PNP epitaxial planar type

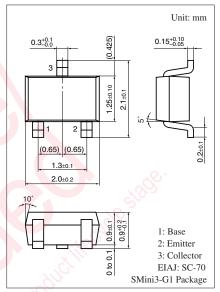
For digital circuits

#### Features

- High forward current transfer ratio h<sub>FE</sub>
- Costs can be reduced through downsizing of the equipment and reduction of the number of parts
- S-Mini type package, allowing automatic insertion through tape packing and magazine packing

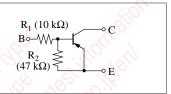
### Absolute Maximum Ratings $T_a = 25^{\circ}C$

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Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-30	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-30	v
Collector current	I <sub>C</sub>	-100	mA
Total power dissipation	P <sub>T</sub>	150	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C



Marking Symbol: EV

#### Internal Connection



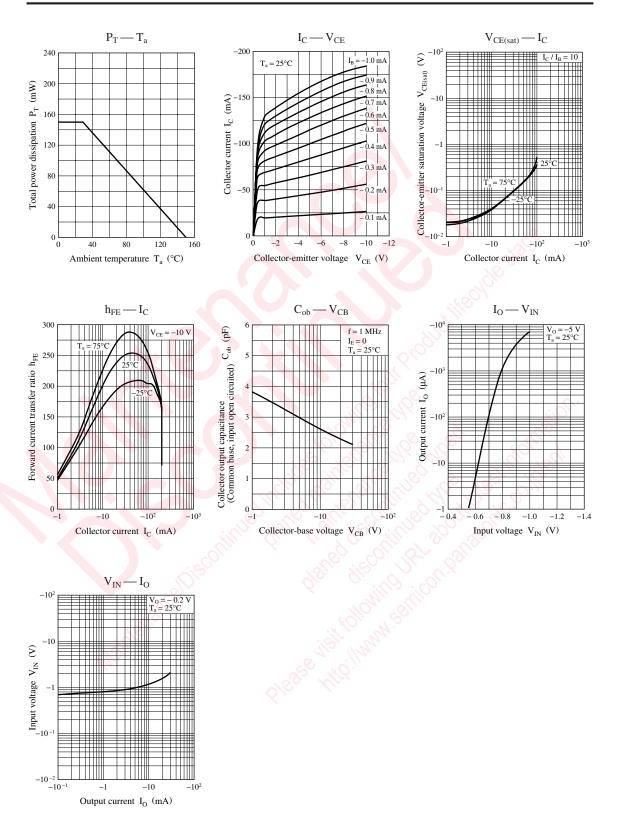
#### Symbol Conditions Parameter Min Тур Max Unit $I_{\rm C} = -10 \ \mu A, I_{\rm E} = 0$ -30 v Collector-base voltage (Emitter open) V<sub>CBO</sub> Collector-emitter voltage (Base open) $I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$ -30v V<sub>CEO</sub> Collector-base cutoff current (Emitter open) $V_{CB} = -30 \text{ V}, I_E = 0$ -0.1μA I<sub>CBO</sub> $V_{CE} = -30 \text{ V}, I_B = 0$ Collector-emitter cutoff current (Base open) I<sub>CEO</sub> -0.5 $V_{EB} = -3 V, I_C = 0$ Emitter-base cutoff current (Collector open) - 0.1 I<sub>EBO</sub> mА $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ Forward current transfer ratio 80 $h_{FE}$ Collector-emitter saturation voltage V<sub>CE(sat)</sub> $I_{\rm C} = -50 \text{ mA}, I_{\rm B} = -0.33 \text{ mA}$ -0.5-1.2V $V_{CC} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1 \text{ k}\Omega$ Output voltage high-level VOH -4.9 v $V_{CC} = -5 V, V_B = -2.5 V, R_L = 1 k\Omega$ Output voltage low-level v - 0.2 VOL Transition frequency $\mathbf{f}_{\mathrm{T}}$ $V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$ 80 MHz Input resistance $R_1$ -30% 10 +30% kΩ Resistance ratio $R_1/R_2$ 0.213

Electrical Characteristics  $T_a = 25^{\circ}C \pm 3^{\circ}C$ 

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Note) The part number in the parenthesis shows conventional part number.

## **Panasonic**



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